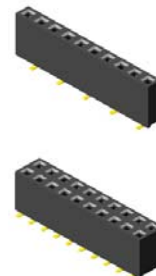
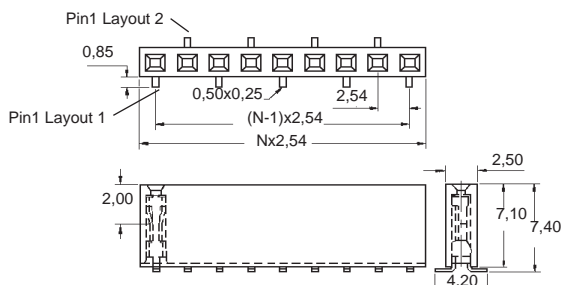




SMD Buchsenleisten Raster 2,54mm / SMT Female Header pitch 2,54mm

Serie 198

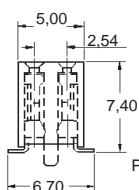
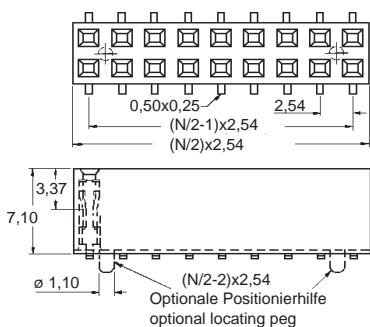


Bauhöhe 7,40mm
total height 7,40mm

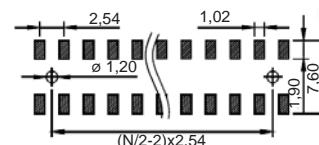
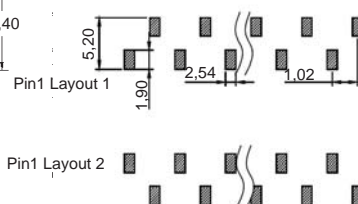
Für Vierkantstift 0,64mm
for square pin 0,64mm



Raster / Pitch
2,54mm



Empfohlenes Leiterplatten Layout
Recommended P.C.B. Layout
(PCB Tolerance $\pm 0,05$)



Technische Daten / Technical Data
 Isolierkörper / Insulator
 Kontaktmaterial / Contact material
 Nennspannung / Current Voltage
 Nennstrom / Current Rating
 Temperaturbereich / Temperatur Range
 Lötwärmebeständigkeit / Resistance soldering

PA 4.6 / 30%GF(UL94-V0)
 CuSn6
 250V AC
 3 A
 -40°C...+125°C
 235°C (30-60 sec.)
 260°C (10 sec.)

weitere Informationen auf Anfrage / more information on request

Bestellbeispiel
How to order

Bitte ersetzen Sie X durch unten aufgeführten Code
Please replace X with coding listed below

198	PL	XX	X	1	X	X	X	X	-	X	X
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Veredelung / Plating

00= verzinkt / tin plated FL= flash vergoldet / flash gold plating

Anzahl Reihe / Number of row

1= 1-reihig / 1-row 2= 2-reihig / 2-row

Ausführung / Version

1= stehend / standing

Raster / Pitch

2= 2,54mm 3= 5,08mm 9= Sonderraster / other pitch

1 = Layout 1 (1-reihig) ohne Positionierhilfe / Layout 1 (1-row) without locating peg
 2 = Layout 2 (1-reihig) ohne Positionierhilfe / Layout 2 (1-row) without locating peg

0 = 2-reihig ohne Positionierhilfe / 2-row without locating peg
 1 = 2-reihig mit Positionierhilfe ø 1,10 / 2-row with locating peg ø 1,10

Polzahl / Number of contacts

04...36 (1-reihig / 1-row) 06...60 (2-reihig / 2-row)

Verpackung / Packaging

01 = in Stangen ohne PP-Pad (auf Anfrage) - in tubes without PP-Pad (on request)
 11 = in Stangen mit PP-Pad (auf Anfrage) - in tubes with PP-Pad (on request)
 12 = auf Rolle mit PP-Pad (Standard) - reel packing with PP-Pad (standard)